

AMENDMENT UNDER 37 C.F.R. § 1.116

Application No.: 09/964,693

Atty Docket No.: Q66444

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application:

LISTING OF CLAIMS:

Claim 1 (currently amended): An antistatic vinyl chloride resin molding, which comprises a base layer comprising a vinyl chloride resin, an intermediate layer and an antistatic layer containing a conductive material and being laminated on at least one side of said base layer, wherein the base layer comprises from 5 to 50 parts by weight of a titanium compound and 100 parts by weight of a vinyl chloride resin, wherein the thickness of the base layer is from 1 to 15 mm, and the intermediate layer comprises a vinyl chloride resin having a chlorination degree of from 58 to 73% and has a composition different from that of the base layer, wherein the thickness of the intermediate layer is from 30 to 500 μ m.

Claim 2 (currently amended): An antistatic vinyl chloride resin molding, which comprises a base layer comprising a vinyl chloride resin, an intermediate layer and an antistatic layer containing a conductive material and being laminated on at least one side of said base layer, wherein said base layer comprises a vinyl chloride resin having a chlorination degree of from 58 to 73%, wherein the thickness of the base layer is from 1 to 15 mm and the intermediate layer comprises a vinyl chloride resin having a chlorination degree of from 58 to 73% and has a composition different from that of the base layer, wherein the thickness of the intermediate layer is from 30 to 500 μ m.

Claim 3 (canceled).

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Atty Docket No.: Q66444

Claim 4 (previously presented): An antistatic vinyl chloride resin molding, which comprises a base layer comprising a vinyl chloride resin, an intermediate layer and an antistatic layer containing a conductive material and being laminated on at least one side of said base layer, wherein said base layer comprises 100 parts by weight of a vinyl chloride resin having a chlorination degree of less than 58% and from 0.1 to 2.5 parts by weight of a molybdenum compound, wherein the thickness of the base layer is from 1 to 15 mm, and the intermediate layer comprises a vinyl chloride resin having a chlorination degree of from 58 to 73% and has a composition different from that of the base layer, wherein the thickness of the intermediate layer is from 30 to 500 μm .

Claims 5-15 (canceled).

Claim 16 (canceled).

Claim 17 (currently amended): An antistatic vinyl chloride resin molding, which comprises a base layer comprising a vinyl chloride resin, an intermediate layer and an antistatic layer containing a conductive material and being laminated on at least one side of said base layer, wherein the base layer comprises a vinyl chloride resin having a chlorination degree of from 58 to 73%, wherein the thickness of the base layer is from 1 to 15 mm, and the intermediate layer has a thickness of less than 200 μm , does not contain titanium oxide, comprises a vinyl chloride resin having a chlorination degree of less than 58% and has a composition different from that of the base layer.

Claim 18 (canceled).

AMENDMENT UNDER 37 C.F.R. § 1.116

Application No.: 09/964,693

Atty Docket No.: Q66444

Claim 19 (currently amended): The antistatic vinyl chloride resin molding according to any one of claims 1, 2, 4, ~~16~~, or 17 ~~or 18~~, wherein the antistatic layer comprises, as a binder resin, a vinyl chloride resin having a chlorination degree of from 58 to 73%, and a conductive material.

Claim 20 (currently amended): The antistatic vinyl chloride resin molding according to any one of claims 1, 2, ~~4~~, ~~16~~, or 17 ~~or 18~~, wherein the antistatic layer comprises, as a binder resin, an ultraviolet curing or thermosetting resin, and a conductive material.

Claim 21 (currently amended): The antistatic vinyl chloride resin molding according to any one of claims 1, 2, ~~4~~, ~~16~~, or 17 ~~or 18~~, wherein the conductive material is at least one of tin oxide, a conductive titanium oxide, and a twisting and entangling ultra thin long carbon fiber.

Claim 22 (currently amended): The antistatic vinyl chloride resin molding according to ~~any one of claims 1, 2, 4, 16, 17 or 18~~ claim 17, wherein the thickness of the intermediate layer is from 25 to 150 μm .

Claim 23 (currently amended): An antistatic vinyl chloride resin molding, which comprises a transparent base layer comprising a vinyl chloride resin having a chlorination degree of from 58 to 73% and a tin system heat stabilizer, wherein the thickness of the base layer is from 1 to 15 mm, an intermediate layer having a thickness of from 50 to 350 μm , comprising a vinyl chloride resin having a chlorination degree of from 58 to 73% and having a composition different from that of the base layer, and an antistatic surface layer having a thickness of from ~~0.10.3~~ 0.10.3 to 1.5 μm and containing a conductive material, wherein the conductive material is at least one of tin oxide and a conductive titanium oxide, wherein it has a total light transmittance of 40% ~~62%~~ 62% or more and a haze value of ~~60%~~ 8.3% or less when its thickness is ~~3mm~~ 3.3mm.